

General Description

The 3205B uses advanced trench technology and design to provide excellent RDS(ON). It can be used in a wide variety of applications.

Features

- Fast switching
- 100% avalanche tested
- 175°C Operating Temperature
- RoHS Compliant

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	65	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	130	A
$I_D@T_C=100^\circ C$	Continuous Drain Current	100	A
I_{DM}	Pulsed Drain Current	520	A
EAS	Single Pulse Avalanche Energy	1000	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	260	W
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 175	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62.5	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-case	---	0.75	$^\circ C/W$

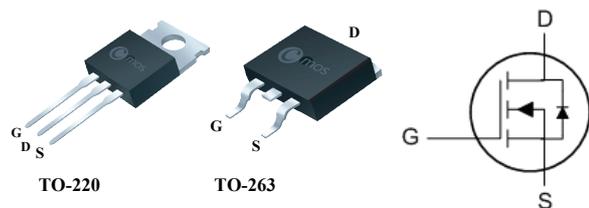
Product Summary

BVDSS	RDSON	ID
65V	5.8m Ω	130A

Applications

- LED power controller
- DC-DC & DC-AC converters
- High current, high speed switching
- Solenoid and relay drivers
- Motor control, Audio amplifiers

TO-220/263 Pin Configuration



Type	Package	Marking
CMP3205B	TO-220	CMP3205B
CMB3205B	TO-263	CMB3205B

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

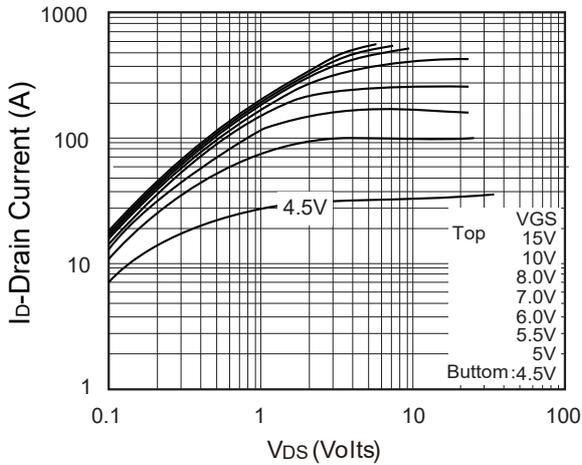
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	65	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=30A$	---	---	5.8	m Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	2	---	4	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=60V, V_{GS}=0V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA
gfs	Forward Transconductance	$V_{DS}=10V, I_D=10A$	---	20	---	S
R_g	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	---	2.2	---	Ω
Q_g	Total Gate Charge	$I_D=30A$	---	125	---	nC
Q_{gs}	Gate-Source Charge	$V_{DD}=35V$	---	25	---	
Q_{gd}	Gate-Drain Charge	$V_{GS}=10V$	---	50	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=35V, I_D=2A$	---	21	---	ns
T_r	Rise Time	$R_L=15\Omega$	---	20	---	
$T_{d(off)}$	Turn-Off Delay Time	$R_G=2.5\Omega$	---	70	---	
T_f	Fall Time	$V_{GS}=10V$	---	31	---	
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1\text{MHz}$	---	5850	---	pF
C_{oss}	Output Capacitance		---	410	---	
C_{rss}	Reverse Transfer Capacitance		---	315	---	

Diode Characteristics

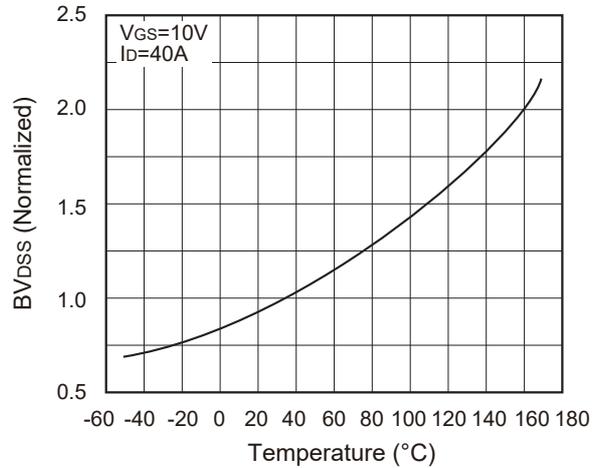
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	130	A
I_{SM}	Pulsed Source Current		---	---	520	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=45A, T_J=25^{\circ}\text{C}$	---	---	1.2	V

Note :

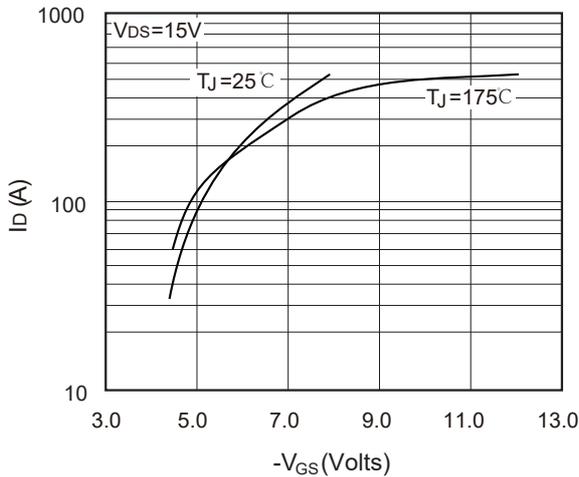
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 Cmos reserves the right to improve product design, functions and reliability without notice.



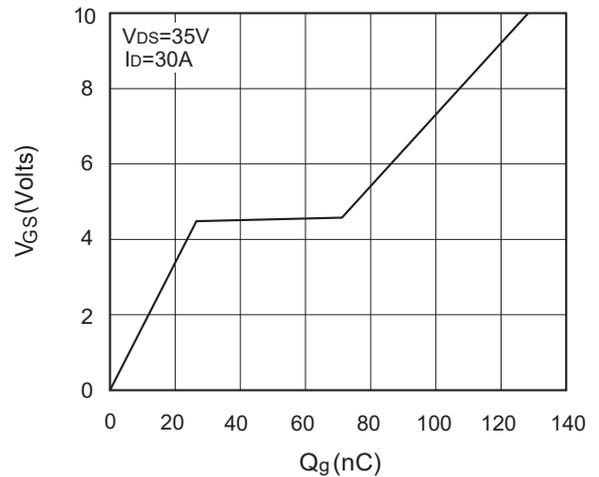
On-Region Characteristics



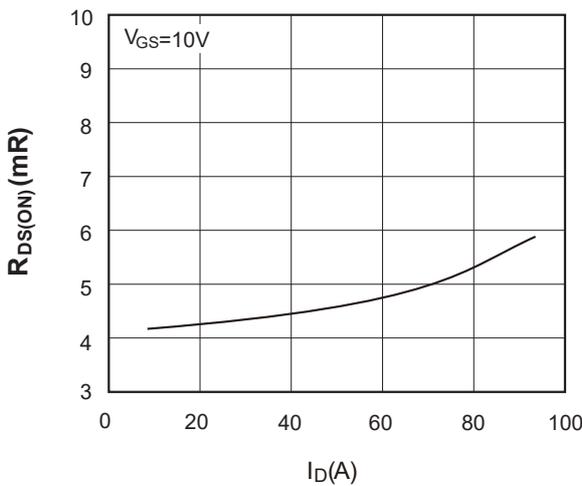
On-Resistance vs. Junction Temperature



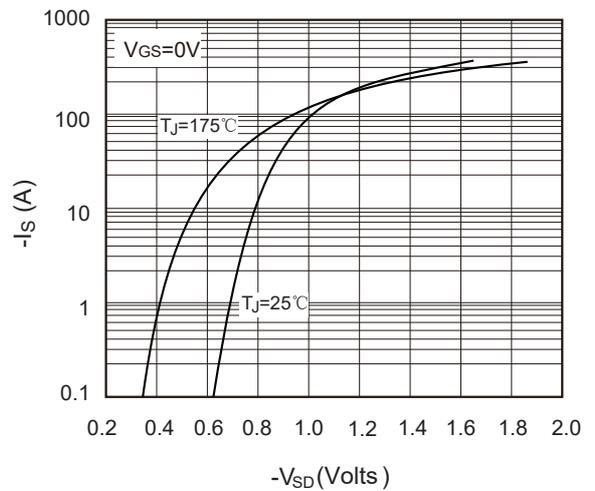
Transfer Characteristics



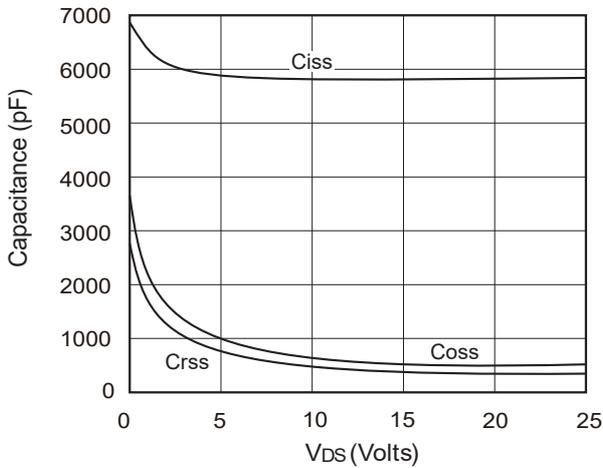
Gate-Charge Waveforms



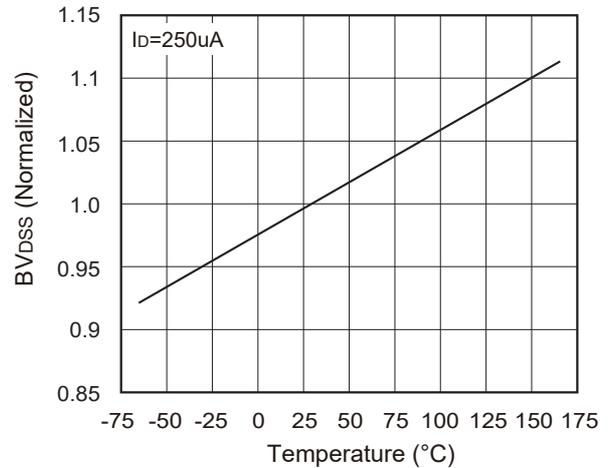
On-Resistance vs. Drain Current and Gate



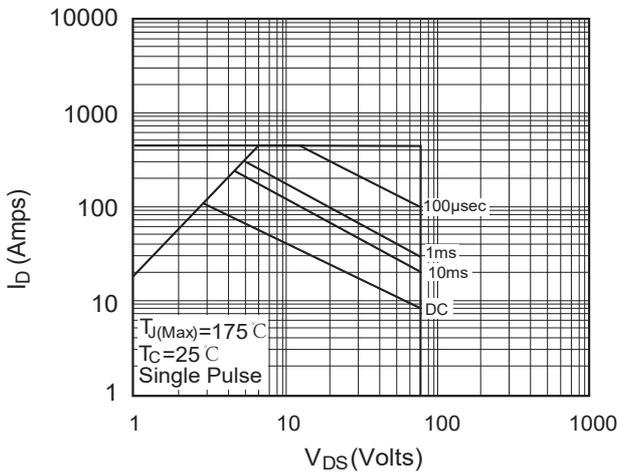
Body-Diode Characteristics



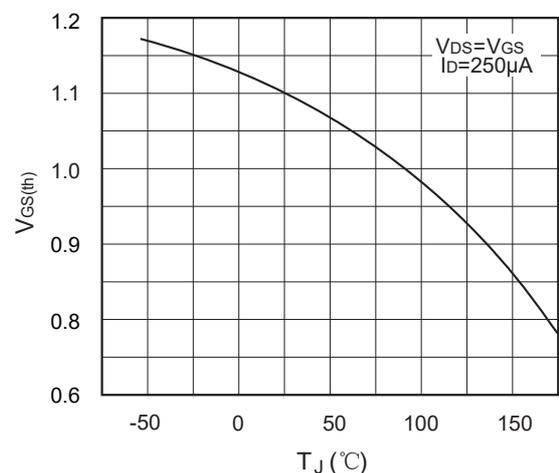
Capacitance Characteristics



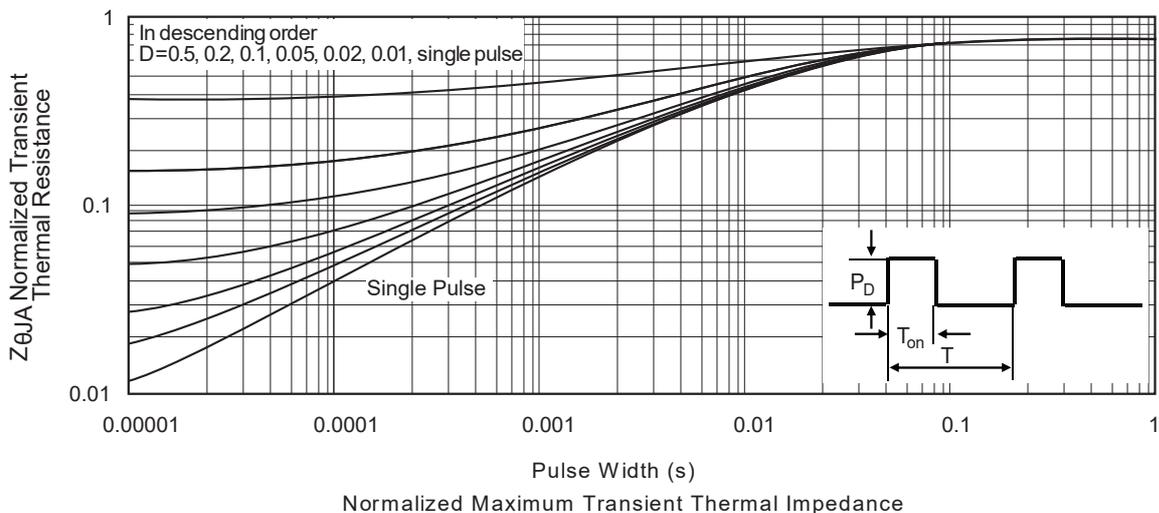
BV_{DSS} vs. Junction Temperature



Maximum Forward Biased Safe Operating Area



$V_{GS(th)}$ vs Junction Temperature



Normalized Maximum Transient Thermal Impedance